



HIGH EFFICIENCY GLASS PASSIVATED RECTIFIER

HER251G THRU HER258G

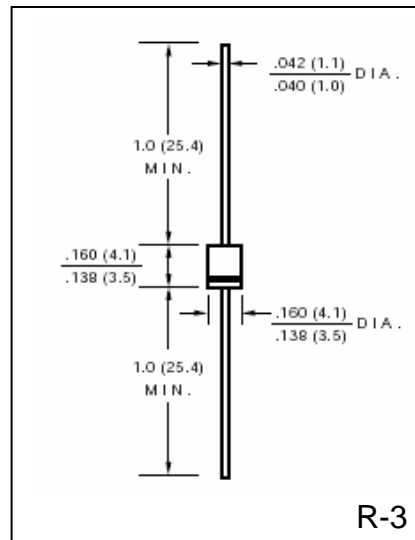
VOLTAGE RANGE 50 to 1000 Volts
CURRENT 2.5 Ampere

FEATURES

- Glass passivated chip junction
- Low power loss, high efficiency
- Low Leakage
- High speed switching
- High Surge Capacity
- High Temperature soldering guaranteed:
260°C / 10 second, 0.375" (9.5mm) lead length

MECHANICAL DATA

- Case: Transfer molded plastic
- Epoxy: UL94V – 0 rate flame retardant
- Polarity: Color Band denotes cathode end
- Lead: Plated axial lead, solderable per MIL – STD-202E Method 208C
- Mounting Position: Any
- Weight: 0.020 ounce, 0.56 gram



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

	SYMBOLS	HER 251G	HER 252G	HER 253G	HER 254G	HER 255G	HER 256G	HER 257G	HER 258G	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	300	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	210	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	300	400	600	800	1000	Volts
Maximum Average Forward Rectified Current, At $T_A = 50^\circ C$	$I_{(AV)}$	2.5								Amps
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method)	I_{FSM}	150								Amps
Maximum Instantaneous Forward Voltage @ 2.5A	V_F	1.0		1.3		1.5		1.7		Volts
Maximum DC Reverse Current at Rated $T_A = 25^\circ C$	I_R	5.0								μA
DC Blocking Voltage per element $T_A = 125^\circ C$		250								
Maximum Full Load Reverse Current, Full Cycle average 0.375" (9.5mm) lead length at $T_L = 55^\circ C$	$I_{R(AV)}$	100								μA
Maximum Reverse Recovery Time Test conditions $I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A$	t_{rr}	50						70		nS
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)	C_J	30						35		pF
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	35								$^\circ C/W$
Operating Junction Temperature Range	T_J	(-55 to +150)								$^\circ C$
Storage Temperature Range	T_{STG}	(-55 to +150)								$^\circ C$

Notes:

1. Thermal resistance from junction to ambient with 0.375" (9.5mm) lead length, PCB mounted

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

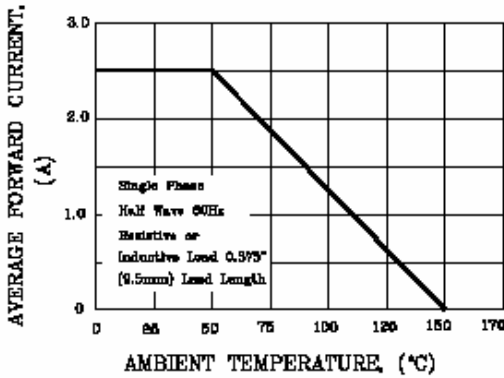


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

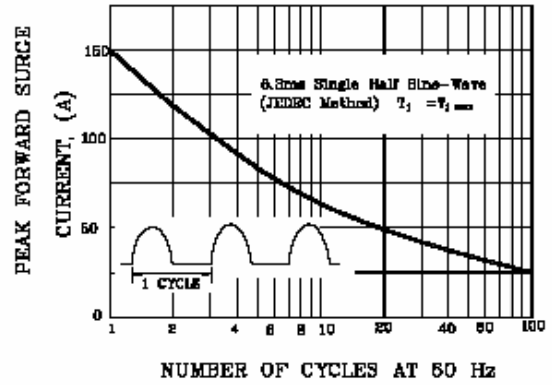


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

